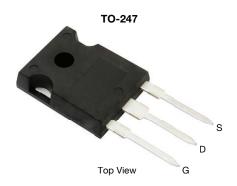


Vishay Siliconix

HALOGEN

FREE

N-Channel 150 V (D-S) 175 °C MOSFET



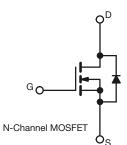
PRODUCT SUMMARY					
V _{DS} (V)	150				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10 \text{ V}$	0.0054				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 7.5 \text{ V}$	0.0060				
Q _g typ. (nC)	110				
I _D (A)	100 ^d				
Configuration	Single				

FEATURES

- ThunderFET® power MOSFET
- Low R_{DS} Q_g figure-of-merit (FOM)
- Maximum 175 °C junction temperature
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous rectification
- Power supplies
- DC/AC inverter
- DC/DC converter
- · Solar micro inverter
- · Motor drive switch



ORDERING INFORMATION				
Package	TO-247			
Lead (Pb)-free and halogen-free	SUG80050E-GE3			

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	150	V	
Gate-source voltage		V_{GS}	± 20	V	
Continuous dunin comment	T _C = 25 °C		100 ^d		
Continuous drain current	T _C = 125 °C	l _D	100 ^d		
Pulsed drain current (t = 100 μs)		I _{DM}	300	A	
Continuous source-drain diode current		I _S	100 ^d		
Single pulse avalanche current ^a		I _{AS}	100		
Single pulse avalanche energy ^a L = 0.1 mH		E _{AS}	500	mJ	
Maritan and a district and a	T _C = 25 °C	5	500 b	10/	
Maximum power dissipation	T _C = 125 °C	P _D	167 ^b	W	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	90	
Soldering recommendations (peak temperature) c			260	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	MAXIMUM	UNIT		
Maximum junction-to-ambient (PCB mount) c		R _{thJA}	40	°C/W		
Maximum junction-to-case (drain)	Steady state R _{thJC} 0.3		C/W			

Notes

- a. Duty cycle ≤ 1 %
- b. See SOA curve for voltage derating
- c. When mounted on 1" square PCB (FR4 material)
- d. Package limited

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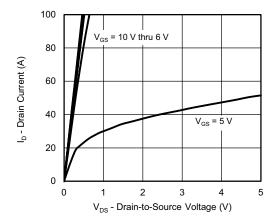
PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	-	4	V	
Gate-source leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	250	nA	
		$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}$	-				
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 150 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$	-	-	150	μA	
		V_{DS} = 150 V, V_{GS} = 0 V, T_J = 175 °C	-	-	5	mA	
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	30	-	-	Α	
Drain-source on-state resistance a	D	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$ - 0.0045 0.		0.0054		
Dialii-Source oii-state resistance "	R _{DS(on)}	$V_{GS} = 7.5 \text{ V}, I_D = 15 \text{ A}$	-	0.0050	0.0063	Ω	
Forward transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 20 \text{ A}$	-	60	-	S	
Dynamic ^b							
Input capacitance	C _{iss}		-	6250	-	pF	
Output capacitance	C _{oss}	$V_{DS} = 75 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	1100	-		
Reverse transfer capacitance	C _{rss}		-	65	-		
Total gate charge	Qg		-	110	165	nC	
Gate-source charge	Q_{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	33	-		
Gate-drain charge	Q _{gd}		-	28	-		
Gate resistance	Rg	f = 1 MHz	0.6	3.1	6.2	Ω	
Turn-on delay time	t _{d(on)}		-	18	27	ns	
Rise time	t _r	$V_{DD} = 75 \text{ V}, \text{ R}_{L} = 5 \Omega, \text{ I}_{D} \cong 15 \text{ A},$	-	44	66		
Turn-off delay time	t _{d(off)}	V_{GEN} = 10 V, R_g = 1 Ω	-	72	108		
Fall time	t _f		-	55	83		
Drain-Source Body Diode Characteristi	cs						
Pulse diode forward current (t = 100 μs)	I _{SM}		-	-	100	Α	
Body diode voltage	V _{SD}	I _F = 15 A, V _{GS} = 0 V	-	0.85	1.5	V	
Body diode reverse recovery time	t _{rr}		-	130	195	ns	
Body diode reverse recovery charge	/ diode reverse recovery charge Q _{rr}		-	0.71	1.07	μC	
Reverse recovery fall time	t _a	I _F = 15 A, dl/dt = 100 A/μs	-	97	-	no	
Reverse recovery rise time	t _b		-	33	-	ns	
Body diode peak reverse recovery charge	I _{RM(REC)}		-	12	18	Α	

Notes

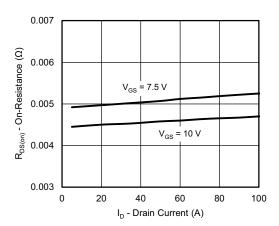
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%$
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

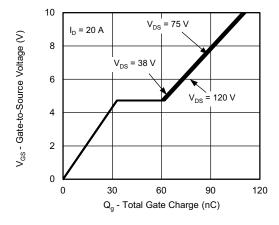




Output Characteristics

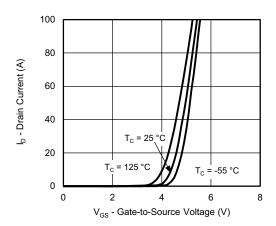


On-Resistance vs. Drain Current and Gate Voltage

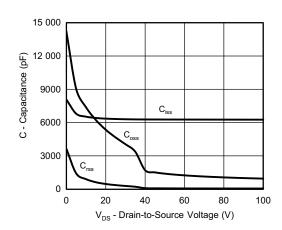


Gate Charge

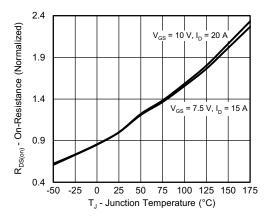
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Transfer Characteristics

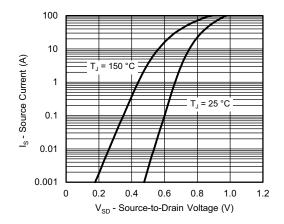


Capacitance

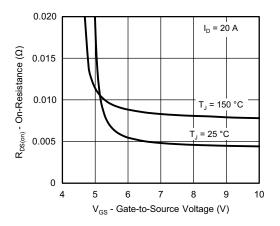


On-Resistance vs. Junction Temperature

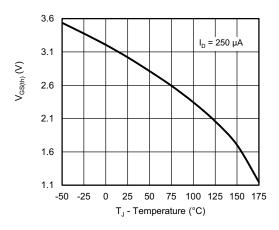




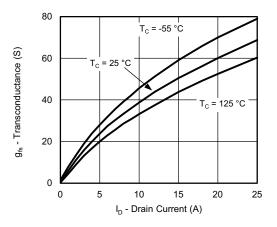
Source-Drain Diode Forward Voltage



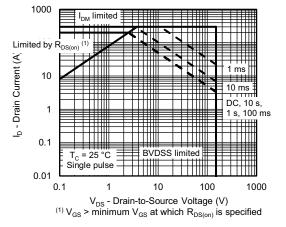
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

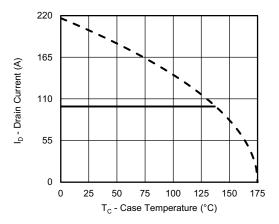


Transconductance

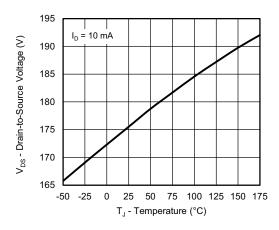


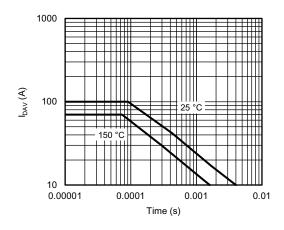
Safe Operating Area, Junction-to-Ambient





Current Derating a





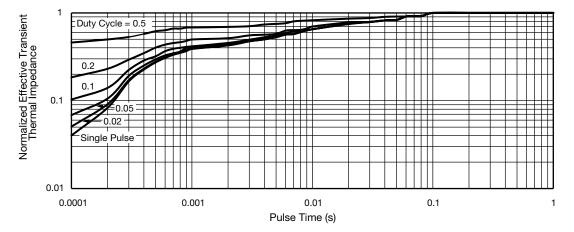
Drain Source Breakdown vs. Junction Temperature

 I_{DAV} vs. Time

Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





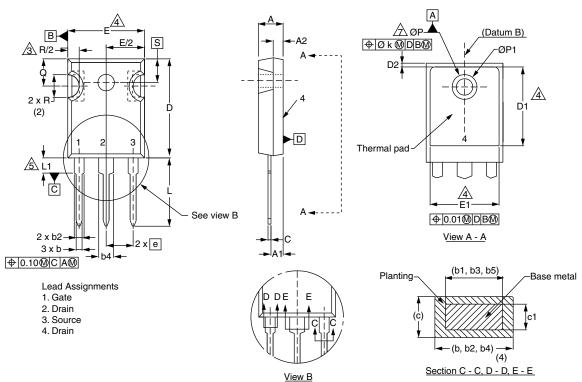
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75186.

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TO-247AC (High Voltage)



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.58	5.31	0.180	0.209
A1	2.21	2.59	0.087	0.102
A2	1.17	2.49	0.046	0.098
b	0.99	1.40	0.039	0.055
b1	0.99	1.35	0.039	0.053
b2	1.53	2.39	0.060	0.094
b3	1.65	2.37	0.065	0.093
b4	2.42	3.43	0.095	0.135
b5	2.59	3.38	0.102	0.133
С	0.38	0.86	0.015	0.034
c1	0.38	0.76	0.015	0.030
D	19.71	20.82	0.776	0.820
D1	13.08	-	0.515	-
ECN: X13-0103-Rev. D, 01-Jul-13				

	MILLIM	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
D2	0.51	1.30	0.020	0.051
E	15.29	15.87	0.602	0.625
E1	13.72	ı	0.540	ı
е	5.46	BSC	0.215	BSC
Øk	0.2	254	0.010	
L	14.20	16.25	0.559	0.640
L1	3.71	4.29	0.146	0.169
N	7.62	BSC	0.300	BSC
ØΡ	3.51	3.66	0.138	0.144
Ø P1	-	7.39	-	0.291
Q	5.31	5.69	0.209	0.224
R	4.52	5.49	0.178	0.216
S	5.51	BSC	0.217	BSC

DWG: 5971

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Contour of slot optional.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions D1 and E1.
 5. Lead finish uncontrolled in L1.
- 6. Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154").
- 7. Outline conforms to JEDEC outline TO-247 with exception of dimension c.
- 8. Xian and Mingxin actually photo.



Revision: 01-Jul-13 Document Number: 91360



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